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Skyworks Expands Suite of SkyLiTE™ Solutions

Devices Support All Major SoC Platforms and a Growing Number of Internet of Things Applications with Embedded Cellular Connections

LAS VEGAS--(BUSINESS WIRE)-- Skyworks Solutions, Inc. (NASDAQ: SWKS), an innovator of high performance analog semiconductors connecting people, places and things, today announced it has expanded its family of SkyLiTE™ front-end solutions powering LTE devices. Originally targeted for mobile platforms in emerging markets, the newest solutions are also being adopted across Internet of Things (IoT) applications that utilize embedded cellular connections such as the connected car and wearables.

The SkyLiTE™ product family incorporates the amplification, switching, Wi-Fi filtering and coupler functionality required to support all major FDD/TDD bands and has been uniquely architected to support the hardware and software compatibility requirements for all major system on a chip platforms. With the addition of external duplexers, this product suite provides OEMs with a scalable and reconfigurable front-end system for broad markets and applications worldwide.

"As the world becomes more connected, OEMs require partners who can deliver system level solutions across traditional as well as new and previously unimagined applications," said Carlos Bori, vice president of marketing for Skyworks Solutions. "With our SkyLiTE™ portfolio, Skyworks is once again delivering the innovation required by customers seeking the highest levels of integration, performance and flexibility spanning the smartphone, automotive, industrial and wearable markets."

According to a September 2015 GfK Projector Model Report, LTE will represent approximately 49 percent of total handsets by 2016, up from 22 percent of total handsets in 2014. Further, according to a recent GSMA Intelligence Report, the machine-to-machine (M2M) market has seen rapid growth globally over recent years as operators and governments recognize the potential of IoT and the number of active deployments starts to accelerate. As of December 2014, there were 243 million cellular M2M connections globally. The total number of cellular M2M connections is expected to grow at a compounded annual growth rate of 26 percent between 2014 and 2020, bringing the total to almost one billion connections. In the automotive sector, Business Intelligence forecasts there will be 100 million new cars shipped with built in connectivity by 2020, up from just 20 million today.

Skyworks' SkyLiTE™ solutions target these fast growing segments.

About Skyworks Expanded Family of SkyLiTE™ Solutions

[SKY77643-21](#) - is a multimode multiband power amplifier module that supports 3G/4G handsets and operates efficiently in WCDMA, TD-SCDMA and LTE modes. The module is fully programmable through a Mobile Industry Processor Interface (MIPI®). The InGaP and silicon die along with the passive components are mounted on a multi-layer laminate substrate and come in a 4.0 x 6.8 x 0.8 mm, 42-pad MCM, SMT package for a highly manufacturable, low cost solution.

[SKY77822-21](#) - is a fully matched, 28-pad surface mount power amplifier module developed for LTE applications. The module includes broadband coverage of FDD LTE Bands 7 and 30, TDD LTE Bands 38/40, and Band 41, all in a compact 4.0 x 3.65 mm package. The device delivers unsurpassed savings in current consumption for data-intensive applications by attaining high efficiencies throughout the entire power range.

[SKY77916-21](#) - is a transmit/receive front-end module that offers the complete transmit VCO-to-antenna and antenna-to-receive SAW filter solution for advanced cellular handsets comprising quad-band GSM, GPRS, EDGE multi-slot operation, and TD-SCDMA and TDD LTE transmission. The FEM fully enables broadband 3G/4G RF switch-through, outward switching of the power amplifier RF inputs, 14 transmit/receive antenna switch ports, and an integrated directional coupler.

[SKY77641](#) - is a multimode multiband power amplifier module that supports 3G/4G handsets and operates efficiently in WCDMA, TD-SCDMA and LTE modes. The module is fully programmable through a MIPI®. The module consists of a WCDMA / LTE block for low, high, and mid-bands, and a multi-function control block with RF input/output ports internally matched to 50 to reduce the number of external components.

Skyworks at CES 2016

Skyworks will be highlighting its Internet of Things product portfolio at the Las Vegas Convention Center, South Hall, Meeting Place 25646 from January 6 - 9.

About Skyworks

Skyworks Solutions, Inc. is empowering the wireless networking revolution. Our highly innovative analog semiconductors are connecting people, places and things spanning a number of new and previously unimagined applications within the automotive, broadband, cellular infrastructure, connected home, industrial, medical, military, smartphone, tablet and wearable markets.

Headquartered in Woburn, Massachusetts, Skyworks is a global company with engineering, marketing, operations, sales, and service facilities located throughout Asia, Europe and North America. For more information, please visit Skyworks' website at: www.skyworksinc.com.

Safe Harbor Statement

This news release includes "forward-looking statements" intended to qualify for the safe harbor from liability established by the Private Securities Litigation Reform Act of 1995. These forward-looking statements include without limitation information relating to future results and expectations of Skyworks (e.g., certain projections and business trends). Forward-looking statements can often be identified by words such as "anticipates," "expects," "forecasts," "intends," "believes," "plans," "may," "will," or "continue," and similar expressions and variations or negatives of these words. All such statements are subject to certain risks, uncertainties and other important factors that could cause actual results to differ materially and adversely from those projected, and may affect our future operating results, financial position and cash flows.

These risks, uncertainties and other important factors include, but are not limited to: uncertainty regarding global economic and financial market conditions; the susceptibility of the semiconductor industry and the markets addressed by our, and our customers', products to economic downturns; the timing, rescheduling or cancellation of significant customer orders and our ability, as well as the ability of our customers, to manage inventory; losses or curtailments of purchases or payments from key customers, or the timing of customer inventory adjustments; the availability and pricing of third-party semiconductor foundry, assembly and test capacity, raw materials and supplier components; changes in laws, regulations and/or policies that could adversely affect either (i) the economy and our customers' demand for our products or (ii) the financial markets and our ability to raise capital; our ability to develop, manufacture and market innovative products in a highly price competitive and rapidly changing technological environment; economic, social, military and geo-political conditions in the countries in which we, our customers or our suppliers operate, including security and health risks, possible disruptions in transportation networks and fluctuations in foreign currency exchange rates; fluctuations in our manufacturing yields due to our complex and specialized manufacturing processes; delays or disruptions in production due to equipment maintenance, repairs and/or upgrades; our reliance on several key customers for a large percentage of our sales; fluctuations in the manufacturing yields of our third-party semiconductor foundries and other problems or delays in the fabrication, assembly, testing or delivery of our products; our ability to timely and accurately predict market requirements and evolving industry standards, and to identify opportunities in new markets; uncertainties of litigation, including potential disputes over intellectual property infringement and rights, as well as payments related to the licensing and/or sale of such rights; our ability to rapidly develop new products and avoid product obsolescence; our ability to retain, recruit and hire key executives, technical personnel and other employees in the positions and numbers, with the experience and capabilities, and at the compensation levels needed to implement our business and product plans; lengthy product development cycles that impact the timing of new product introductions; unfavorable changes in product mix; the quality of our products and any remediation costs; shorter-than-expected product life cycles; problems or delays that we may face in shifting our products to smaller geometry process technologies and in achieving higher levels of design integration; and our ability to continue to grow and maintain an intellectual property portfolio and obtain needed licenses from third parties, as well as other risks and uncertainties, including, but not limited to, those detailed from time to time in our filings with the Securities and Exchange Commission.

The forward-looking statements contained in this news release are made only as of the date hereof, and we undertake no obligation to update or revise the forward-looking statements, whether as a result of new information, future events or otherwise.

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